
PET

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UV

SU8 PMMA

X

LIGA

(SU8)

(MEMS)

X

UV

LIGA

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LIGA

PET

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PET

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PET

RCA#1

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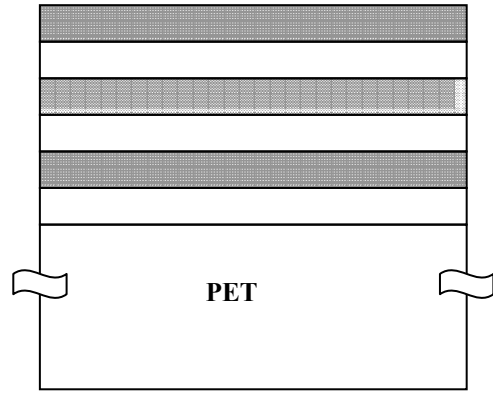
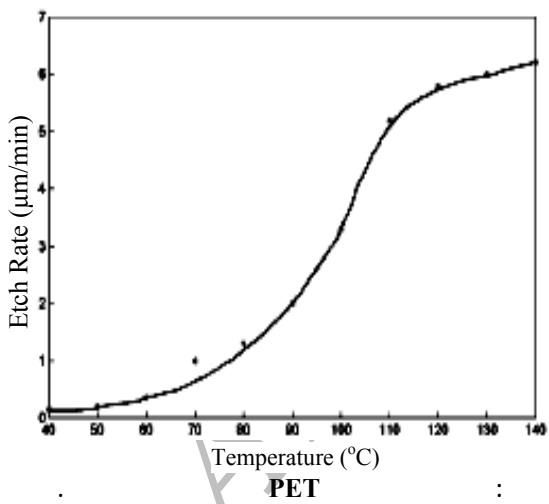
DI

(DCM)

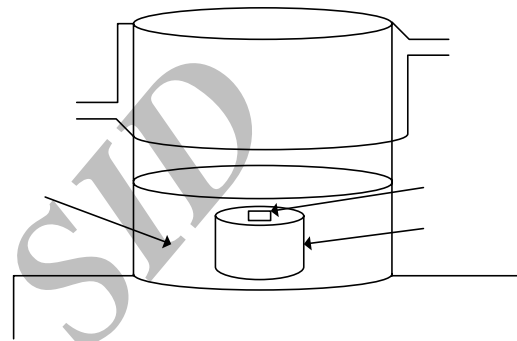
X

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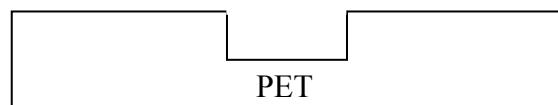
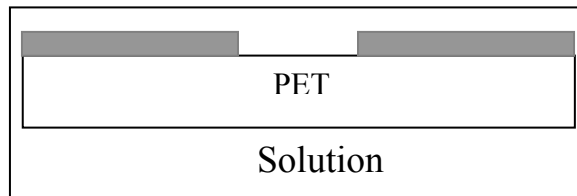
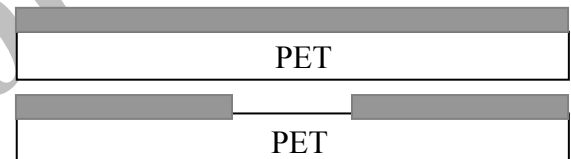
DMF



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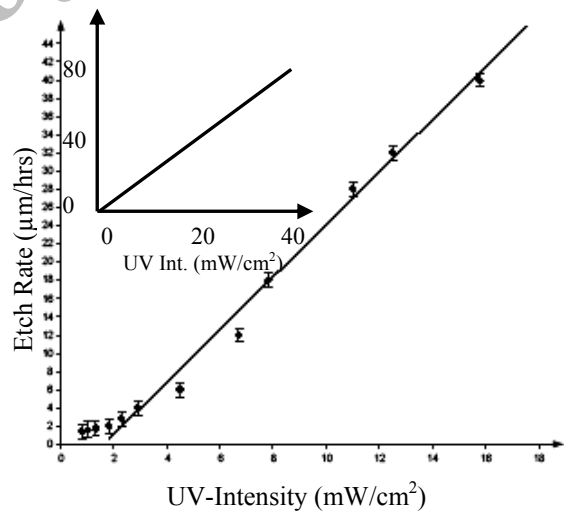
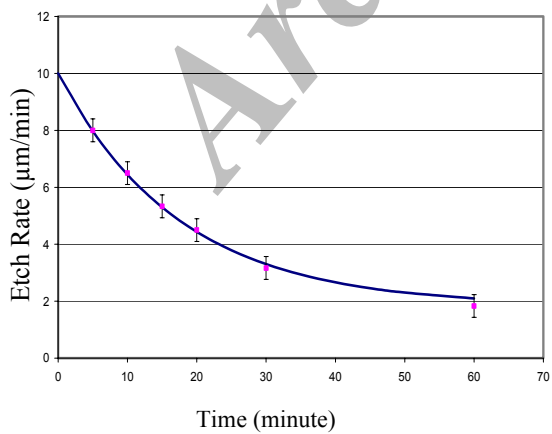
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UV

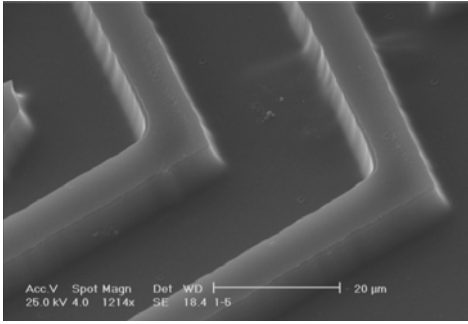
mW/cm²

UV

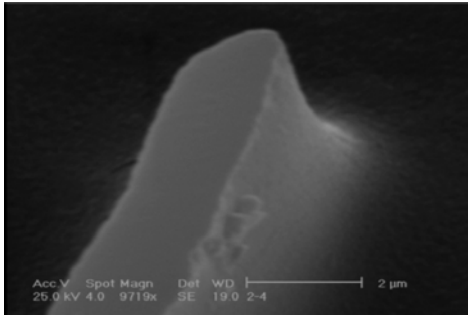


.PET

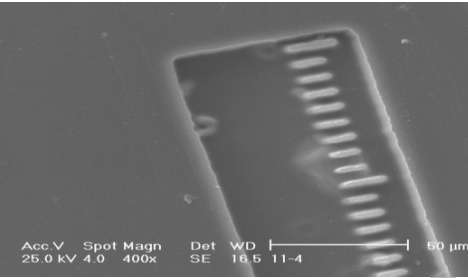
UV



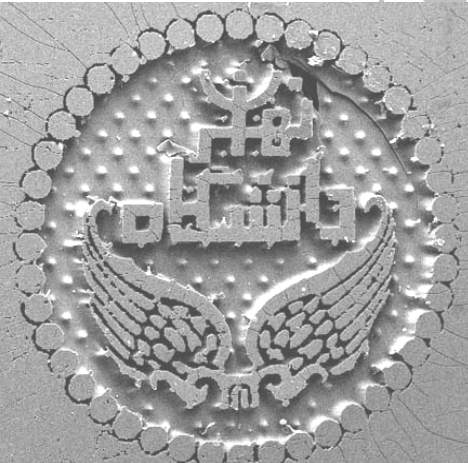
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$$R(t) = (R_0 - R_\infty) \exp(-t/\tau) + R_\infty$$

"t" R(t) R_\infty R_0

/ R_\infty R_0

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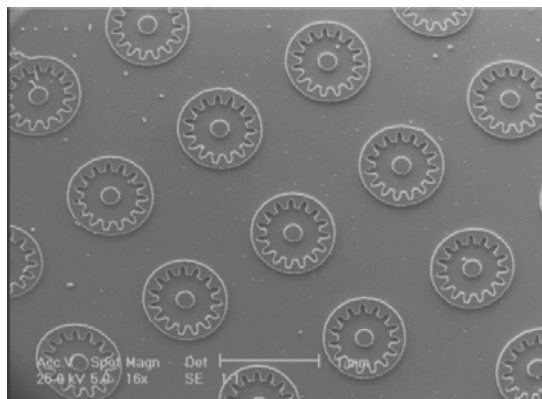
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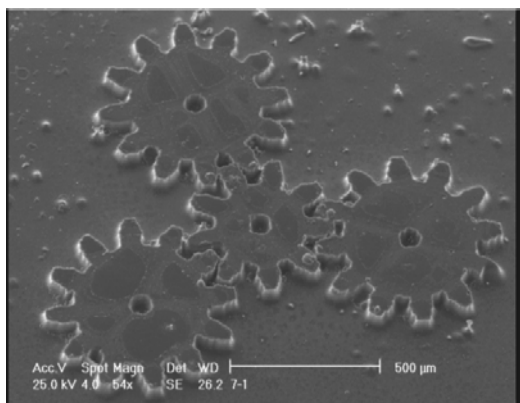
(under-cut)

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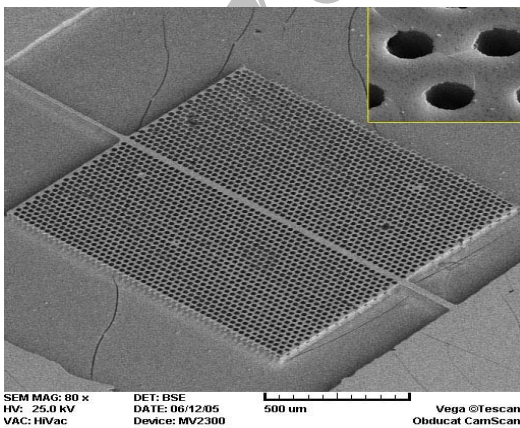
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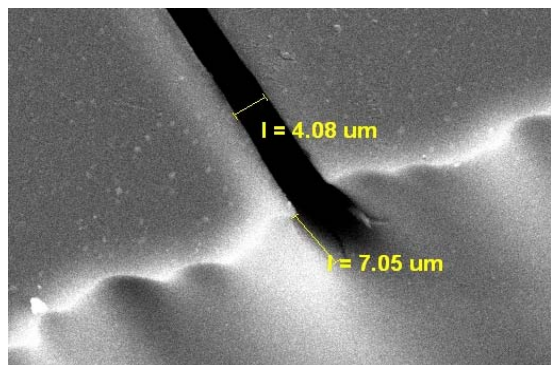
(Dek-Tak 3B)

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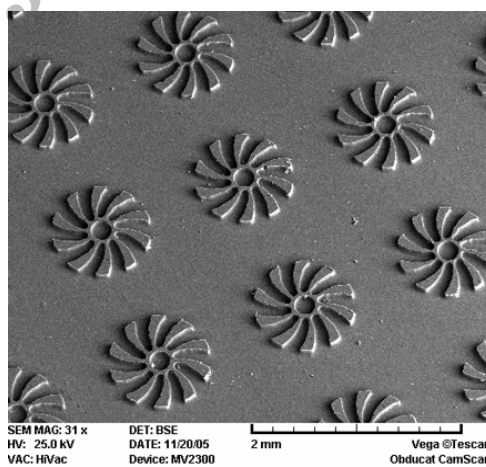
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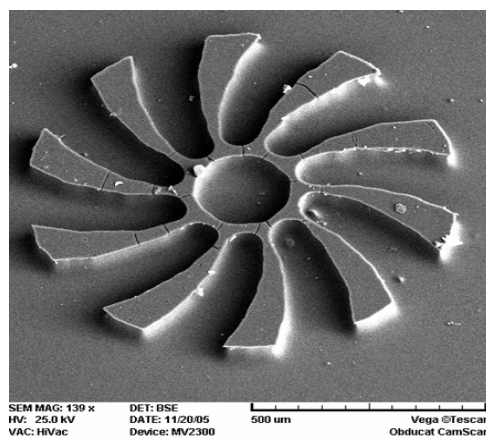
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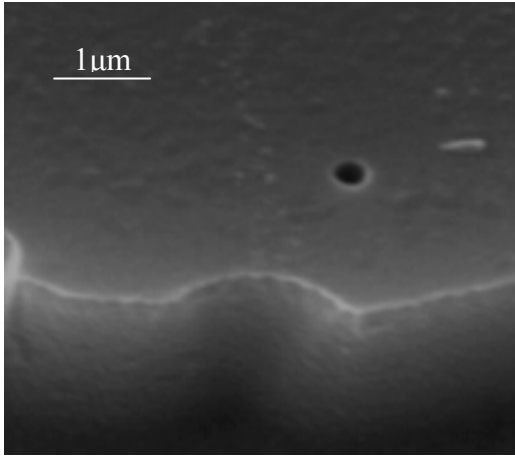


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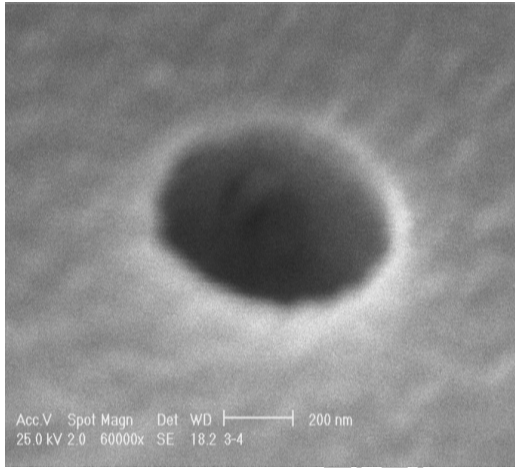
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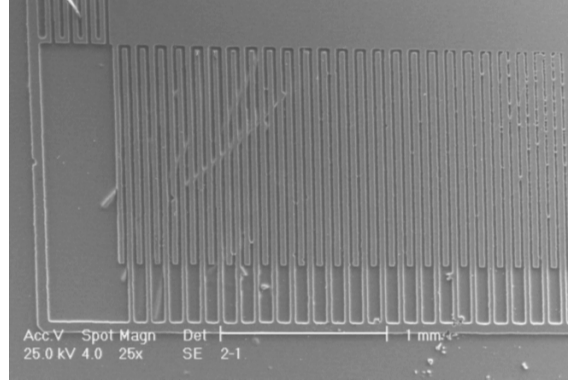
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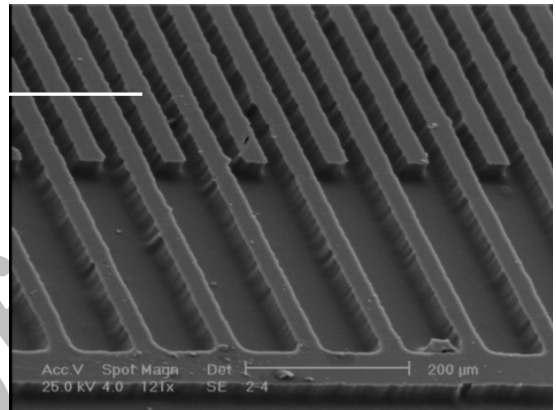
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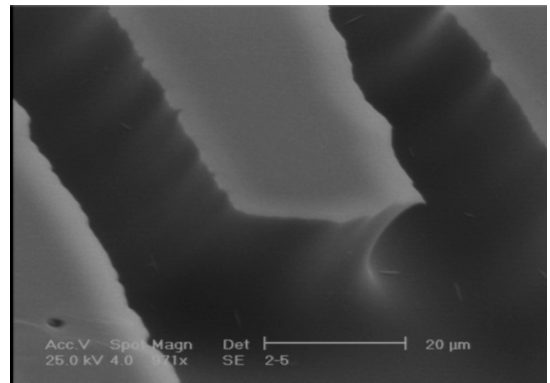
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(inter-digital)

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PET

UV

- 1 - Alavi, M., Schumacher, A. and Wagner, H. J. (1991). "Laser machining and anisotropic etching of <111> silicon for applications in Microsystems." *In Proc. Micro Syst. Technol.*, PP. 227–231.
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- 1 - UV-curable adhesive
- 2 - Poly-Ethylene Terephthalate
- 3 - Di-Methyl-Formamide
- 4 - Di-Chloromethane